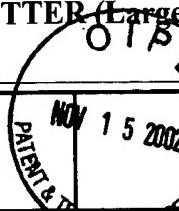


AMENDMENT TRANSMITTAL LETTER (Large Entity)

Applicant(s): K. Sahota et al

Docket No.

E0520CIP

Serial No.
09/749,191Filing Date
December 26, 2000Examiner
L. Umez EroniniGroup Art Unit
1765

Invention: PREVENTION OF PRECIPITATION DEFECTS IN COPPER INTERCONNECTS DURING CMP BY USE
OF
SOLUTIONS CONTAINING ORGANIC COMPOUNDS WITH SILICA ADSORPTION AND COPPER CORROSION
INHIBITING PROPERTIES

TO THE ASSISTANT COMMISSIONER FOR PATENTS:

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	71 -	73 =	0	x \$18.00	\$0.00
INDEP. CLAIMS	5 -	5 =	0	x \$84.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00

- No additional fee is required for amendment.
- Please charge Deposit Account No. in the amount of
A duplicate copy of this sheet is enclosed.
- A check in the amount of to cover the filing fee is enclosed.
- The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 01-0365
A duplicate copy of this sheet is enclosed.
 - Any additional filing fees required under 37 C.F.R. 1.16.
 - Any patent application processing fees under 37 CFR 1.17.


Signature

Dated: November 7, 2002

Deborah W. Wenocur, Reg. No 40,221

Agent for Applicant

Advanced Micro Devices, Inc., Technology Law Dept.
One AMD Place, M/S 68
P.O. Box 3453
Sunnyvale, CA 94088-3453

I certify that this document and fee is being deposited on Nov. 8, 2002 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.16 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.


Signature of Person Mailing Correspondence

Deborah W. Wenocur

Typed or Printed Name of Person Mailing Correspondence

CC: